SUNTEK
Advanced Materials

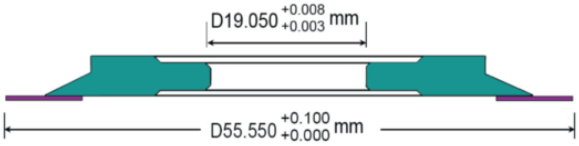
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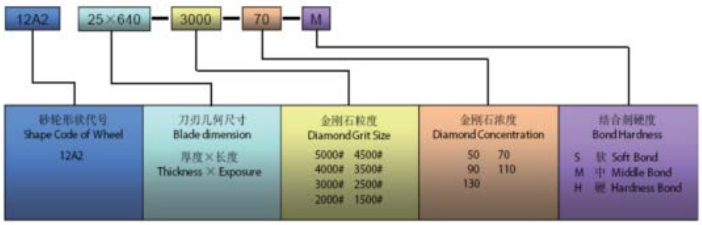
Dicing hub blade

SUNTEK Electroplated bond blades with hub are a kind of upscale new products developed by our institute in last few years, which are used to groove, cut, and dice silicon wafer, GaAs, compound semiconductor material, glass, ceramics, quartz and so on in discrete devices, integrated chips production. This kind of products has high precision and long life, and perfect performance has achieved in China, Taiwan, south-east Asia and America.









厚度基本尺寸 Thickness(μm)	刃长基本尺寸 Exposure(μm) / 实际尺寸范围 Tolerance Range(μm)	380	510	640	760	890	1020	1150	1270	金刚石粒度 Grit Size	金刚石浓度 Diamond Concen.	结合剂硬度 Bond Hardness
		380~510	510~640	640~760	760~890	890~1020	1020~1150	1150~1270	1270~1400			
20	16~20	20×380	20×510							5000	50	S
25	21~25	25×380	25×510	25×640						4500		
30	26~30	30×380	30×510	30×640	30×760	30×890				4000	70	
35	31~35	35×380	35×510	35×640	35×760	35×890	35×1020			3500	90	M
40	36~40	40×380	40×510	40×640	40×760	40×890	40×1020	40×1150		3000		
50	41~50	50×380	50×510	50×640	50×760	50×890	50×1020	50×1150	50×1270	2500	110	
60	51~60		60×510	60×640	60×760	60×890	60×1020	60×1150	60×1270	2000		H
70	61~70			70×640	70×760	70×890	70×1020	70×1150	70×1270		130	
80	71~80					80×890	80×1020	80×1150	80×1270	1500		
90	81~90						90×1020	90×1150	90×1270			

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